

30V N-Channel Enhancement Mode Power MOSFET

Description

WMO150N03T1 uses advanced power trench technology that has been especially tailored to minimize the on-state resistance and yet maintain superior switching performance.

D S G TO-252

Features

- V_{DS} = 30V, I_{D} = 150A $R_{DS(on)}$ < 3m Ω @ V_{GS} = 10V $R_{DS(on)}$ < 6m Ω @ V_{GS} = 4.5V
- Low R_{DS(ON)RR}
- Low Gate Charge
- 100% EAS Guaranteed

Applications

- Power Management
- Load Switch
- PWM Application

Absolute Maximum Ratings

Absolute Maximum Ratings					
Parameter		Symbol	Value	Unit	
Drain-Source Voltage		V _{DS}	30	V	
Gate-Source Voltage		V _G s	±20	V	
Continuous Drain Current@10V1	T _C =25°C	. I _D	150	. А	
	Tc=100°C		98		
Pulsed Drain Current ²		Ірм	602	А	
Single Pulse Avalanche Energy ³		EAS	210	mJ	
Avalanche Current		I _{AS}	29	А	
Total Power Dissipation ⁴	T _C =25°C	P _D	107	W	
Operating Junction and Storage Temperature Range		TJ, Tstg	-55 to 175	°C	

Thermal Characteristics

Parameter	Symbol	Value	Unit
Thermal Resistance from Junction-to-Case ¹	Reuc	1.4	°C/W



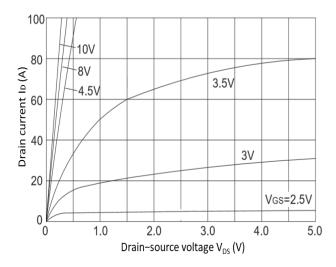
Electrical Characteristics T_c = 25°C, unless otherwise noted

Parameter		Symbol	Test Conditions	Min.	Тур.	Max.	Unit	
Static Characteristics								
Drain-Source Breakdown Voltage		V _{(BR)DSS}	V _{GS} = 0V, I _D = 250μA	30	-	-	V	
Gate-body Leakage current		Igss	$V_{DS} = 0V, V_{GS} = \pm 20V$	-	-	±100	nA	
Zero Gate Voltage Drain Current	T _J =25°C	IDSS	V _{DS} = 30V, V _{GS} = 0V	-	-	1	μA	
Gate-Threshold Voltage		V _{GS(th)}	$V_{DS} = V_{GS}$, $I_D = 250\mu A$	1.0	1.7	2.5	V	
D : 0		_	V _{GS} = 10V, I _D = 30A	-	2.5	3		
Drain-Source On-Resistance	_	R _{DS(on)}	V _{GS} = 4.5V, I _D = 20A		4.6	6.5	mΩ	
Dynamic Characteristics	3							
Input Capacitance		Ciss		-	3486	-		
Output Capacitance	tput Capacitance		$V_{DS} = 15V$, $V_{GS} = 0V$, $f = 1MHz$	-	495	-	pF	
Reverse Transfer Capacitance		C _{rss}		-	430	-		
Switching Characteristic	s							
Total Gate Charge	Total Gate Charge Qg		V _{GS} = 10,V _{DS} = 15V, I _D =30A	-	38.4	1	nC	
Gate-Source Charge		Q _{gs}		-	9.1	1		
Gate-Drain Charge		Q _{gd}		-	13.1	-		
Turn-On Delay Time		t _{d(on)}	$V_{GS} = 10V, \ V_{DS} = 15V,$ $R_G = 3\Omega, \ I_{D} = 30A$	-	25	-	nS	
Rise Time Turn-Off Delay Time		tr		-	24.2	-		
		t _{d(off)}		-	90	-		
Fall Time		tf		-	38	-		
Drain-Source Body Diod	e Characte	eristics		•				
Diode Forward Voltage ²		VsD	I _F = 30A, V _{GS} = 0V	-	-	1.2	V	
Continuous Source Current ^{1,5}		Is	Vg=VD=0V,Force Current	-	-	150	Α	
Body Diode Reverse Recovery Time trr Body Diode Reverse Recovery Charge Qrr			-	41	-	nS		
		Qrr	I _F = 20A, dl/dt= 100A/μs	-	39	-	nC	

Notes:

- 1. The data tested by surface mounted on a 1 inch2 FR-4 board with 2OZ copper.
- 2.The data tested by pulsed , pulse width $\leq 300 \text{us}$, duty cycle $\leq 2\%$
- 3.The EAS data shows Max. rating . The test condition is $V_{\text{DD}}\!=\!15\text{V},\,V_{\text{GS}}\!=\!10\text{V},\,L\!=\!0.5\text{mH},\,I_{\text{AS}}\!=\!29\text{A}$
- 4.The power dissipation is limited by 175°C $\,$ junction temperature
- 5. The data is theoretically the same as I_D and I_{DM} , in real applications, should be limited by total power dissipation.





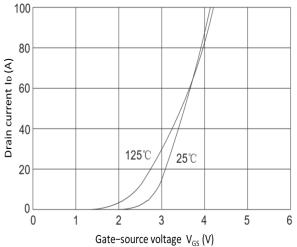
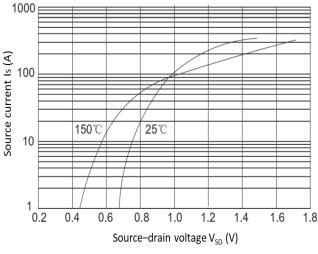


Figure 1. Output Characteristics

Figure 2. Transfer Characteristics



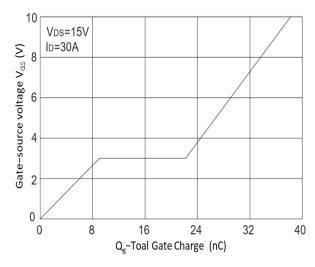
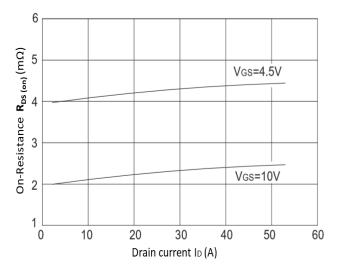


Figure 3. Forward Characteristics of Reverse

Figure 4. Gate Charge Characteristics



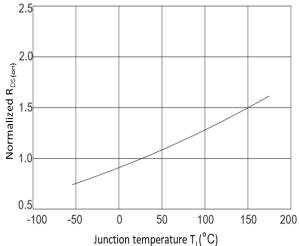


Figure 5. R_{DS}(on) vs. I_D

Figure 6. Normalized R_{DS(on)} vs. T_J



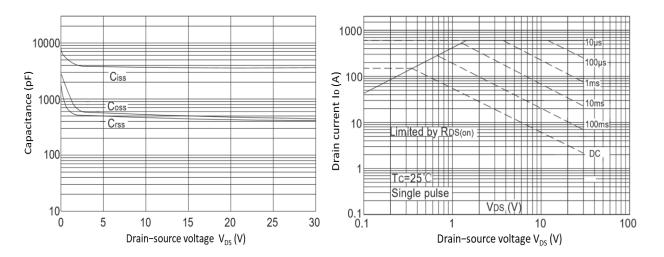


Figure 7. Capacitance Characteristics

Figure 8. Safe Operating Area

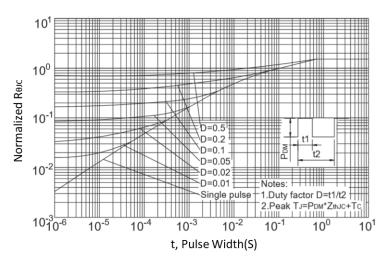


Figure 9. Normalized Maximum Transient Thermal Impedance

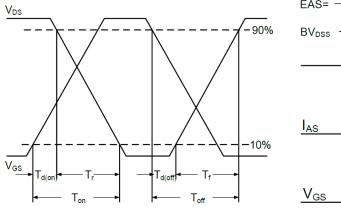


Figure 10. Switching Time Waveform

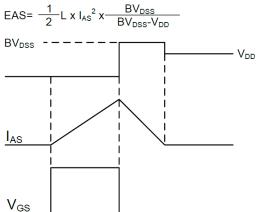
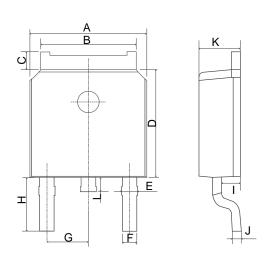


Figure 11. Unclamped Inductive Switching

Waveform



Mechanical Dimensions for TO-252



COMMON DIMENSIONS

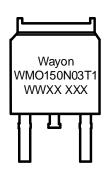
	MM			
SYMBOL	MIN	MAX		
А	6.40	6.80		
В	5.13	5.50		
С	0.88	1.28		
D	5.90	6.22		
Е	0.68	1.10		
F	0.68	0.91		
G	2.29REF			
Н	2.90REF			
1	0.85	1.17		
J	0.51REF			
K	2.10	2.50		
L	0.40	1.00		



Ordering Information

Part	Package	Marking	Packing method
WMO150N03T1	TO-252	WMO150N03T1	Tape and Reel

Marking Information



WMO150N03T1 = Device code WWXX XXX= Date code

Contact Information

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